Highlight on Detector technology

Manqi Ruan

Outline

Introduction

•	MDI:	10 talk	S

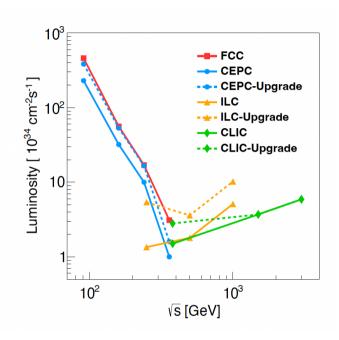
- Silicon: 13 talks
- Gaseous detector:
 14 talks
- Pid & Others: 14 talks
- Calorimeter: 14 talks
- Software & TDAQ:
 17 talks
- Summary

• Disclaimer: apologize for my limited acceptance & mis-interpretations

CEPC Physics

Table 3.1: Main design indicators for the CEPC 30 MW beam power operation scheme

Operation mode	Z	W	Higgs
Center-of-mass energy (GeV)	91	160	240
Operation time (year)	2	1	10
Instantaneous luminosity/IP $(10^{34} \mathrm{cm}^{-2} s^{-1})$	115	16.0	5.0
Integrated luminosity (ab^{-1} , 2 IPs)	60	3.6	12
Event yield (30 MW)	$2.5 imes 10^{12}$	1.0×10^{8}	2.5×10^6
Event yield (50 MW)	$4.0 imes 10^{12}$	1.6×10^8	4.0×10^6



- Huge data: i.e., LEP-I data in o(1) minute
- Extremely high precision/sensitivity: to control uncertainties from
 - Theoretical: new tools/development of theory, high-precision pheno. calculation...
 - Experimental:
 - Stable & high-lumi collider
 - Stable & adequate detector

Requirements & technologies

- Be suited to the collision environment: High radiation, High rate, Beam background
- High hermiticity
- Lower energy/momentum threshold (especially for Z)
- Good intrinsic Energy/Momentum resolution
- A clear separation of the final state particles
 - Physics object identification
 - Resolution for composited objects, i.e., jets
- BMR (Boson Mass Resolution)
 - < 4% for Higgs physics, much demanding for New Physics & Flavor Physics Measurements
- Pid: Pion & Kaon separation > 3σ
- Jet: Flavor Tagging & Charge Reconstruction
- Extremely Stable

Radiation robust detector Fast & low power electronics

Compact forward region, MDI/detector protection

Tracker & Calorimetry: Low noise, High precision Low threshold calorimeter, adequate B-Field, High efficiency tracker

Particle Flow Oriented detector, or Dual Readout (or alternatives)

Abundant high quality detector information + suited algorithm

dEdx or dNdx with resolution ~ 3%, ~ 50 ps ToF (or alternatives)

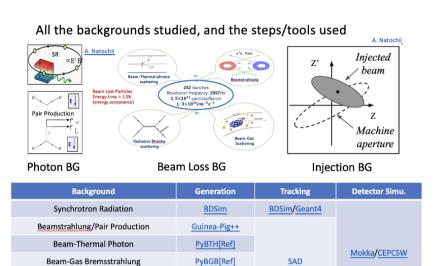
Low material, high precision vertex placed close to the IP

Mechanic & Integration

MDI

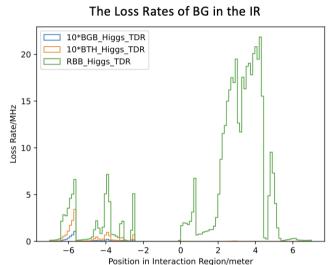


Beam background: CEPC, Belle II, BES III

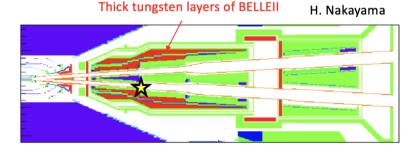


BGC in SAD

BBBREM



With Collimators, the BG in IR has been mitigated significantly

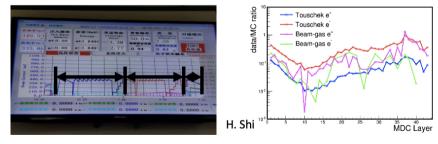


Beam-Gas Coulomb

Radiative Bhabha

The experience at <u>SuperKEKB</u> reminds us to reserve enough space for the BG shields between detectors and beam pipes

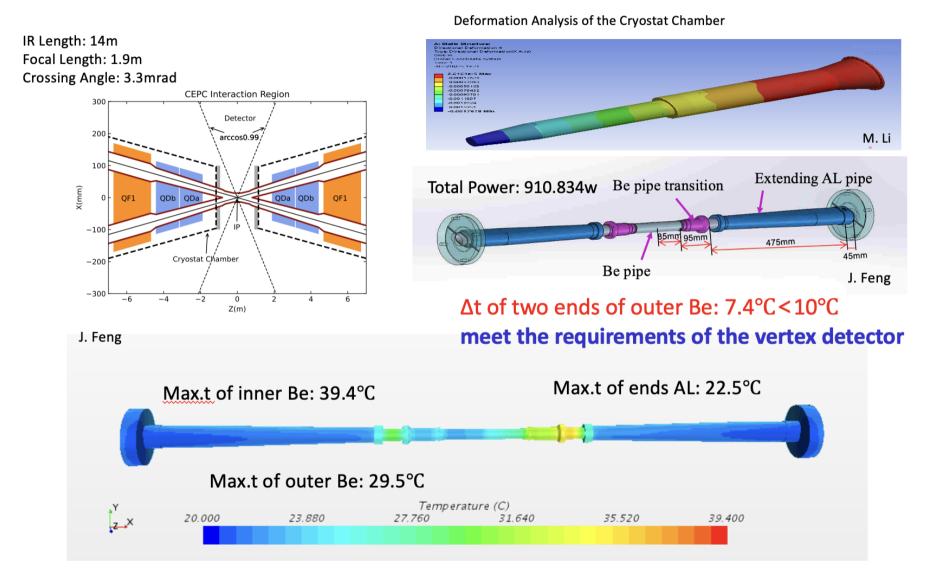
BG Experiment at BESIII/BII in 2021, to check our simulation model. It seems fine.



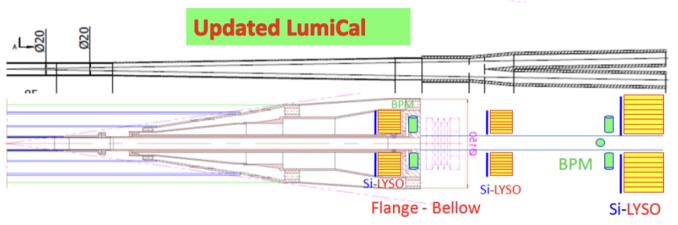
BGs at BII/BESIII dominanted by Touschek and Beam-gas:

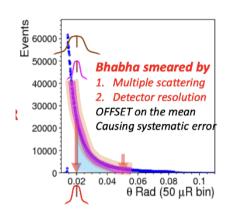
- Touschek: MC is 1~2 order of magnitude higher than experiment
- Beam-gas: fluctuation is caused by small rate and indirect measurement

MDI/beam pipe design

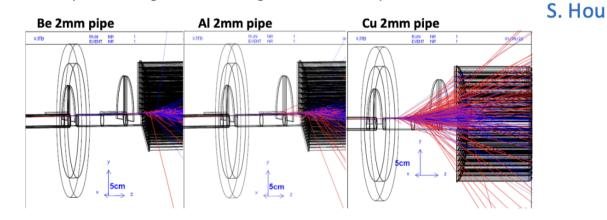


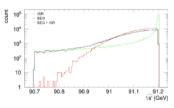
Luminosity monitoring & Impact



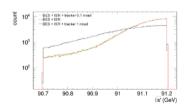


The Multiple scattering due to small angle must be taken special care of

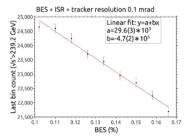




I. Bozovic



With the CEPC post-CDR design, Beam Energy Spread can be determined with the total relative accuracy of 25% corresponding to 9 MeV beam energy uncertainty in only 3 minutes of data-taking at the Z–pole



240 GeV

BES + ISR + tracker resolution 0.1 mrad

Linear fit: y=a+bx
a = 224(5)·10³
b = -54(6)·10⁴

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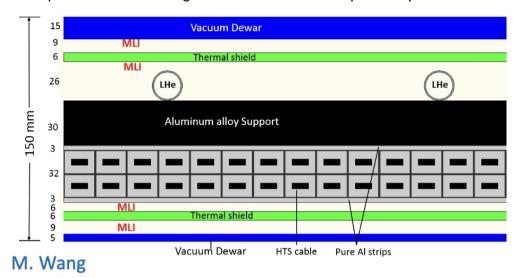
0.076 0.077 0.078 0.079 0.08 0.081 0.082 0.083 0.084

BES (%)

7 pole

BPM @ MDI and Solenoid design

Conceptual mechanical design of the ultra-thin & transparent cryostat - 150mm



Progress of LTS detector magnet

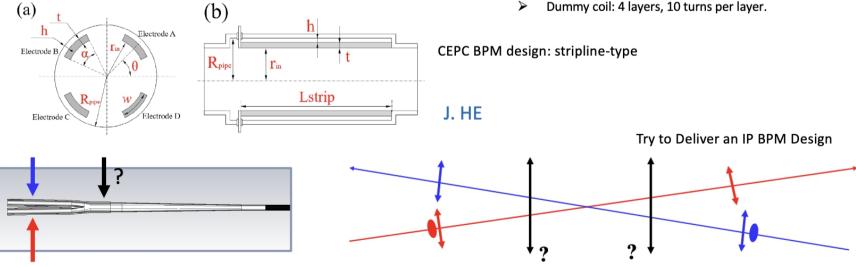


Winding platform of Dummy coil

Dummy cable: 6061 Aluminum alloy, cross section 56mm*22mm

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Dummy coil: 4 layers, 10 turns per layer.



28/10/2022 CEPC Workshop 2022

Silicon

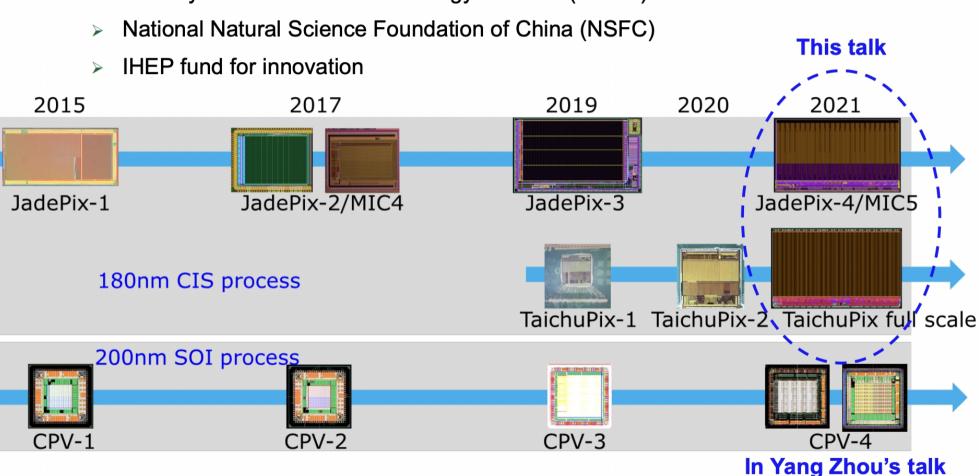


Overview of pixel sensors in China for CEPC VTX



Development of pixel sensors for CEPC VTX supported by

Ministry of Science and Technology of China (MOST)



Ref: "Status report on MAPS in China", 2021 CEPC workshop, Yunpeng Lu

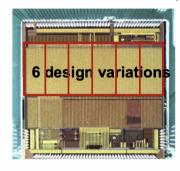
CEPC VTX Chips

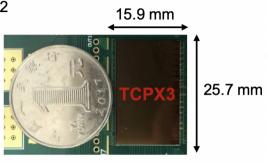


> 1st engineering run

• Full-scale chip: TaichuPix-3, received in July 2022







Residual y

mu = -0.02 μm

Sigma = 4.6 μm

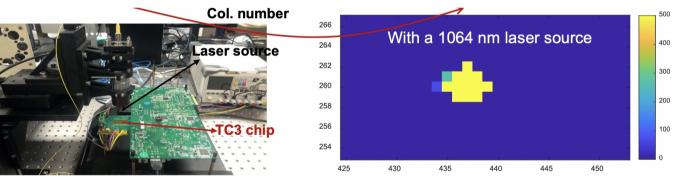
Laser test

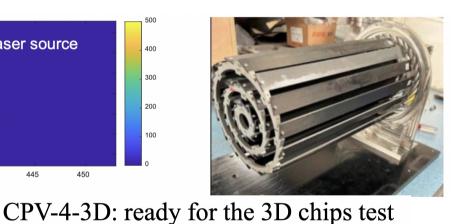
δ(y_{obs} - y_{fit}) (μm)

TaichuPix-1

TaichuPix-2

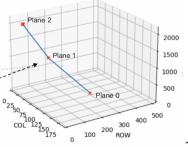
TaichuPix-3 Pixel size: 25 μ m imes 25 μ m





Functionality of the full signal chain proved





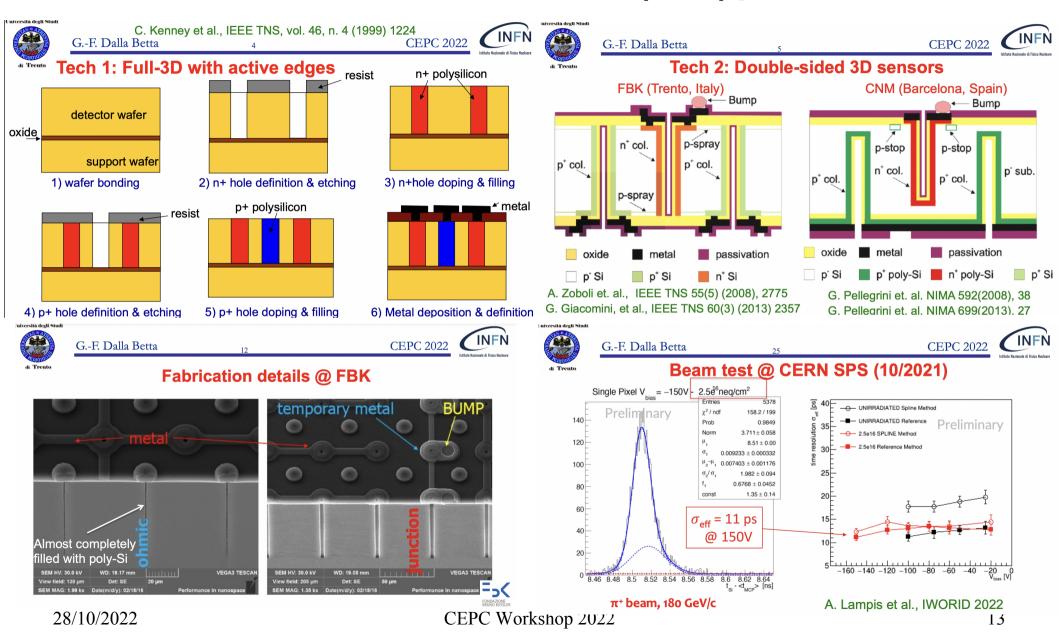




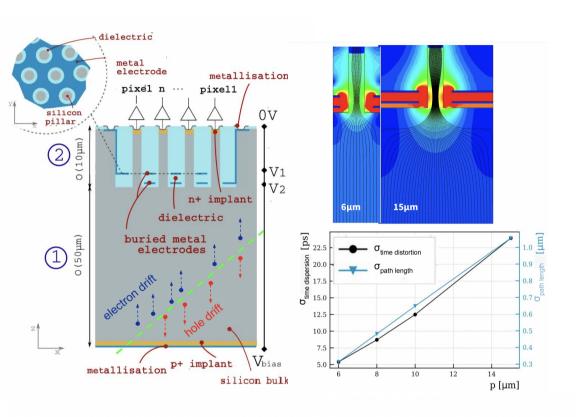
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Combined test beam at DESY: Dec 2022

3D-sensor: \sim o(10)ps!



Silicon electron multiplier sensor



1.33 um Advantages: Small pitch Good time resolution No gain layer deactivation due to acceptor 17.55 µm Our approach

Marius Halvorsen

UNIVERSITETET

I OSLO

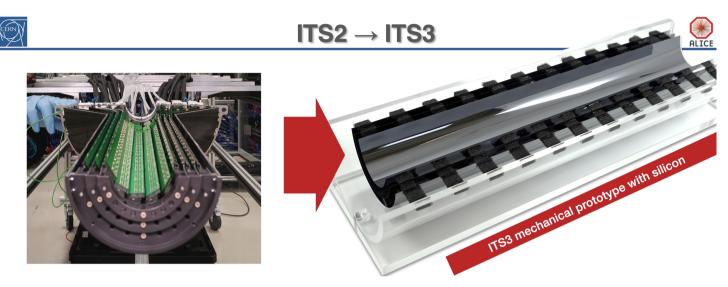
- Future inner tracker detectors will require
 - Time resolutions below 50 ps
 - Pixel pitch down to 25 µm
 - Radiation hardness up to 10¹⁷ n_{eq}

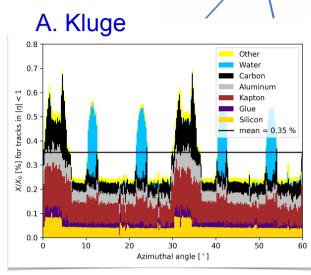
- Gain, doping independent
- Small pitch
- Small thickness, radiation hardness

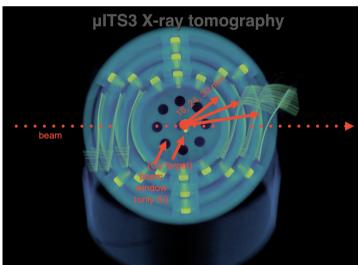
Structure realized via Chemical Etching, enabling lots of future tests: IV, TCT, Beta-source...

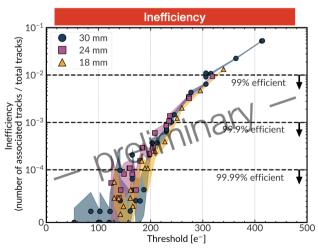
ALICE ITS3

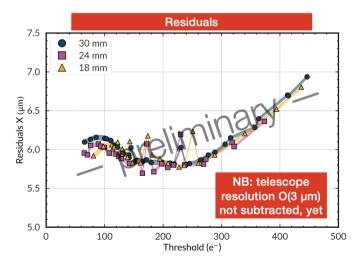








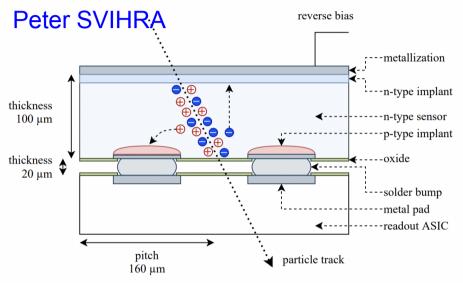




- Bending doesn't show effects in main performance figures.
- Next step to prove stitching and power/signal distribution.
- Far future... put inside the beam pile??

Small pitch pixel detector hybridsation and integration





Generic hybrid pixel detector with planar p-on-n silicon sensor

Small pitch bump bonding

- Single die process developed for 25 μm pitch CLICpix2 hybrid assemblies
 - Very good efficiency results for 50 μm thick sensors
- Laboratory and beam-test results show excellent yield of above 99.7 %

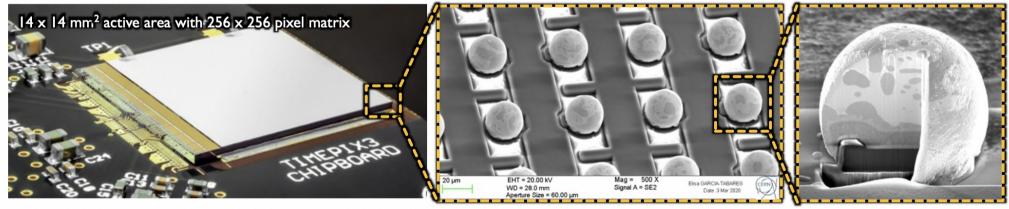
ACF interconnect Anisotropic Conductive Film

- In-house UBM plating and in-house ASIC-sensor connection
 - Extensive ENIG studies to achieve uniform metal growth
- Good yield achievable for 55 μm pitch, better control of ENIG required
- Ongoing improvements of the bonding parameters and ACF materials
- ACF can be also used for module integration

Timepix3 ASIC bump-bonded to a 50 µm active edge silicon sensor

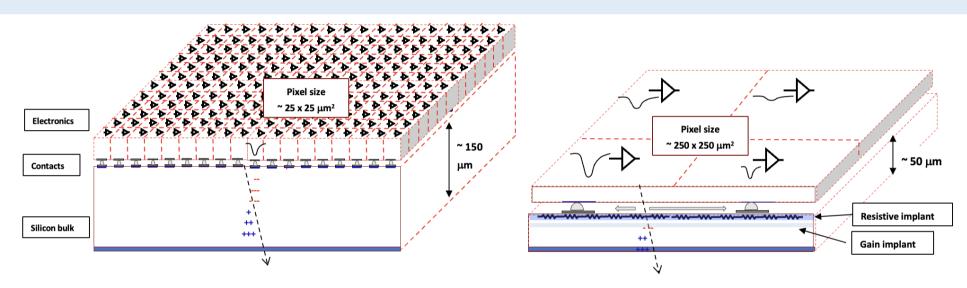
Solder pumps on the Himepixo pixel matrix

המוווה הו הפפ-פברמהוו



LGAD - 4D tracking

A complete new tracker based on RSD



Standard Silicon Detector

Resistive Silicon Detector

The innovative design of a tracker based on RSD

- ➤ It delivers ~ 30 -40 ps temporal resolution
- > For the same spatial resolution, the number of pixel is reduced by 50-100
- > The electronic circuitry can be easily accommodated
- > The power consumption is much lower, it might even be air cooled (~ 0.1-0.2 W/cm²)
- > The sensors can be really thin

M. Ferrero
INFN Torino

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Belle II VTX & upgrade

Setting the Scene

Belle II Vertex Detector (VXD)

- Silicon Vertex Detector (SVD)
- 4 layers of 2-sided silicon strips
- o r≤140 mm

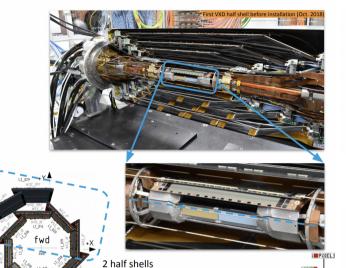
Pixel Vertex Detector (PXD)

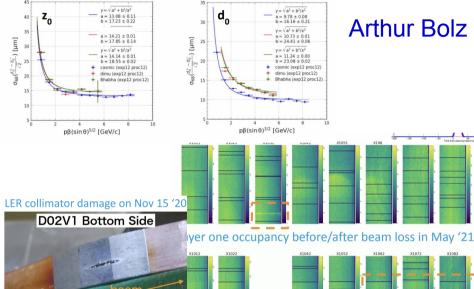
- o 2 layers at radii 14 mm and 22 mm
- 8 inner + 12 outer module-pairs ("ladders")
 - ⇒ only 8 (inner) + 2 (outer) ladders installed
- ~7.7 x 10⁶ pixels
- ~0.21 % X_o / layer material budget

acceptance

- o 17° < Θ < 150°
- p_T ≥ 40 MeV

DESY.





VTX simulated tracking performances

Context = full Belle II simulation framework, including background

Realistic pixel sensor model

- Digitizer assuming
- -fully depleted thin layer 30 µm
- -Pixel 33x33 µm² with 7bits Time over Threshold
- Tuned with Monopix-1 beam data

Geometry

- Taken from fast simulation
- 5 or 7 barrel layers with/without 2 forward disks
- Crude layer description but with targeted material budget \rightarrow per layer: 0.1 % X₀ for radii <4 cm then 0.3 % X₀

Full tracking chain

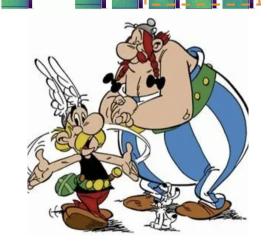
- VTX standalone
- CDC standalone then combined

Belle 2
VTX 5 Layer
VTX 7 Layer

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Jerome Baudot

Tech. Monopix Obelix



ÍPHC

Power supply, HV CMOS

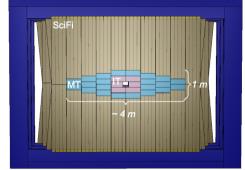
Mighty Tracker

Ivan Peric

VS.



- SciFi Tracker
 - Scintillating fibres with SiPM readout
- Inner Tracker and Middle Tracker
 - Silicon sensors meet requirements of radiation hardness and granularity
 - Baseline technology: HV-CMOS pixel chip MightyPix
 - In total over 46000 silicon sensors to cover area of 18 m² (minus beam-pipe hole)



Schematic of one layer of the Mighty Tracker. [1]

Parameter	Required Value	Notes
Chip size	~2 cm × 2 cm	
Pixel size	$\sim 50~\mu m \times 150~\mu m$	
Time resolution	< 3 ns	Hit assigned to right BX
Power consumption	$< 0.15 \text{ W/cm}^2$	
NIEL ³	6×10^{14} 1 MeV n_{eq}/cm^2	Includes safety factor of 2
Cooling	< 0°C	Test beam studies

First prototype MightyPix-1 submitted this May

bPOL48V (buck) production grade

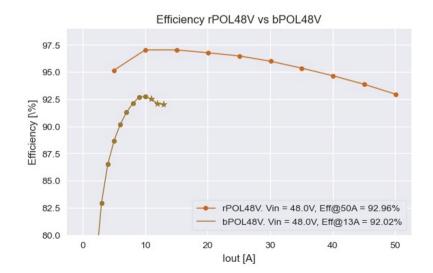




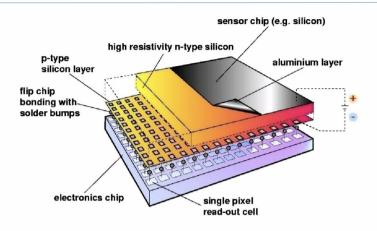
rPOL48V (resonant)





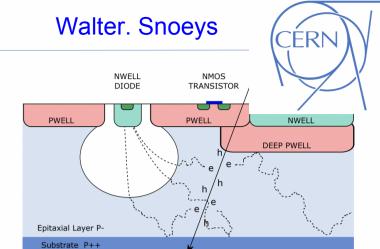


Hybrid vs Monolithic



Hybrid

- Large majority of presently installed systems
- 100 % fill factor easily obtained
- Sensor and ASIC can be optimized separately
- Spin-off from HEP developments:
 for example spectral photon counting chips in this workshop



Monolithic

- Easier integration, lower cost
- Potentially better power-performance ratio and strong impact on material budget

Motivation for intense R&D since more than 30 years

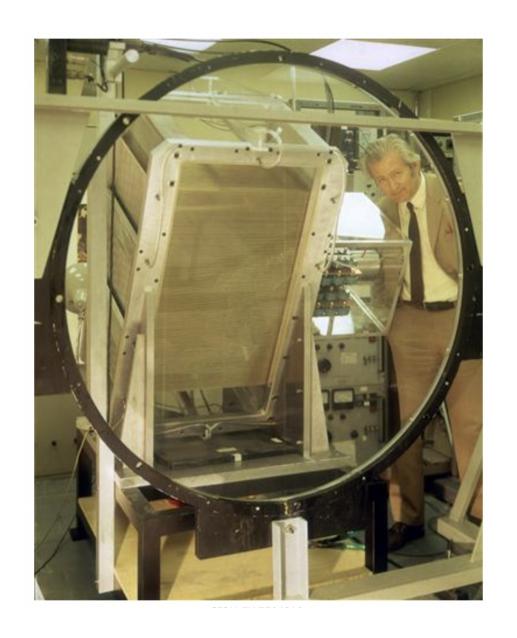
Trend towards more standard technologies

New technologies (TSV's, microbumps, wafer stacking...) make the distinction more vague.

walter.snoeys@cern.ch

MAPS are one of the few areas where production volume even within HEP would not be negligible, but where our community can have an impact not only on the quality of its own measurements, but also on society in general, and which we should try to exploit to enable access to the most advanced technologies.

Gaseous Detector



Gas detectors: Time Projection Chambers for CEPC

- New ILD strategy and consequences on ILD tracking
- TPC = "ultimate" drift chamber, with 3D precision tracking with low material budget and PID through dE/dx or cluster counting
- Main recent progress on
 - Use of multiple layers of MPGDs (GEM or Micromegas) to significantly reduce ion back-flow (IBF) even without gating (crucial for circular colliders)
 - Use of MPGDs with pad/pixelated readout to reduce occupancy (crucial for high-lumi runs @Z).
- The possibility to use a TPC at the future Higgs factory is appealing (particle ID for free, low material), but requires a large amount of difficult studies to meet physics requirements of Z peak at the highest luminosity of circular colliders. Ion backflow suppression without loss of resolution
 - Possibility to correct for distortions (on average? or event by event?)
 - Especially difficult at the Z peak at the highest luminosity
 - What is our requirement for resolution at the Z peak?
 - Update all beam background estimates at the HZ energy.

r 2

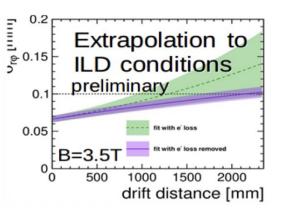
In-situ calibration of distortion?

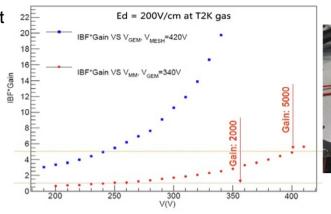
- Tracks corresponding to positive/negative charge, will be biased towards different direction:
 - Increase of Pt for one charge and decrease for another.
- · Larger biases at higher Pt.
- Z -> mumu events happens at a rate of 2k Hz (1/20 of Hadronic Z), while the momentum shall be measured to a relative precision of 0.1% at each track.
- I guess the full energy lepton tracks, especially muon ones, can provide a solid reference for the correction...
- · But certainly needs more quantification!

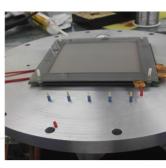


TPC R&D - pad TPC technology

- Pad TPC with multiple GEMs or GEMs/Micromegas:
 - IBFxGain ~1 at Gain=2000 in recent testbeams with GEM/MM readout
 - Hit resolution of σ_{rφ}≤100 μm at ILD conditions also achieved

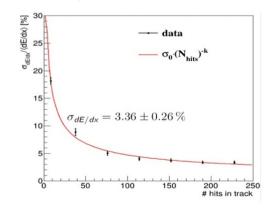


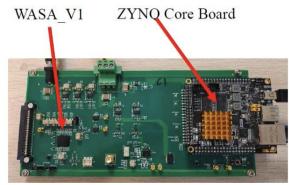




- TPC prototype recently developed by CEPC with integrated 266nm UV laser to generate pseudo-tracks
 - dE/dx about 3.4% for (pseudo-)tracks with 220 hits (as expected for CEPC baseline detector concept)





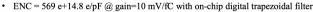


R&D on Macro-Pixel TPC Readout

Long term Goal: power consumption ~ 0.1 w/cm²

Summary

- A 16 channel low power readout ASIC WASA has been successfully developed and evaluated
 - The power consumption is 4.94 mW/ch @ 40 MHz
 - P_{AFE}=1. 38 mW/ch
 - $P_{ADC} = 0.83 \text{ mW/ch}$
 - $P_{Digital} = 2.73 \text{ mW/ch}$



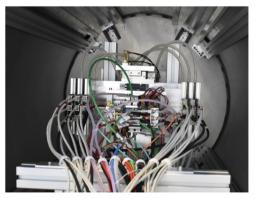
Next step: BGA package 16 x 11 (11.05 mm x 7.8 mm)

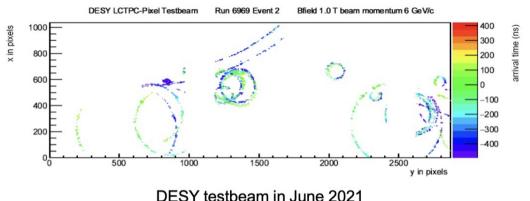
TPC R&D - pixelated technology

 Initial Timepix3-based GridPix detector module tests already indicate excellent tracking and dE/dx performance (4.1% resolution for 1m track length)

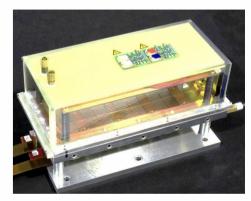
https://arxiv.org/abs/1902.01987

• Prototype with 160 GridPixes covering an active area of 320 cm² (10M pixel detector) also built and tested in beam at B=1T in DESY in June 2021, to prove large-scale production, integration, and readout => 1e6 events successfully collected





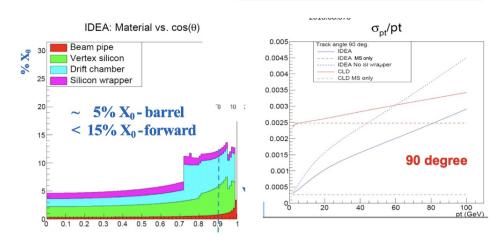
- Development of new ASIC (Timepix4) ongoing (lower power consumption, easier assembly, better coverage)
- dN/dx cluster counting: should be feasible with high granularity readout, challenging for low power consumption, to be addressed by dedicated R&D.
- Preliminary full simulation studies (Geant4) foresee, compared to pad TPC w/ 6mm pads:
 - Momentum resolution improvement: 15%
 - dE/dx improvement: 30% (with cluster counting)

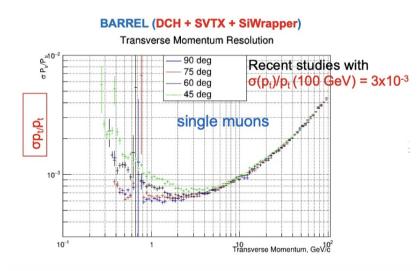


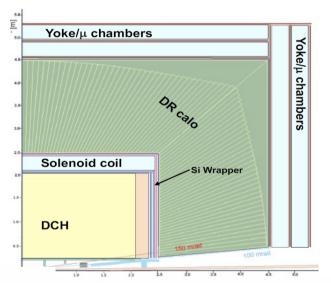
■ The current power consumption is 1W/cm². So good cooling is important but in my opinion no show stopper; but needs extensive R&D.

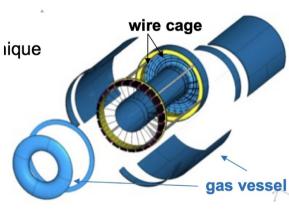
 Transparent drift chamber to minimise multiple scattering contribution to p⊤ resolution at low p⊤

- 112 coaxial layers, L = 4m, 0.35m < R < 2m => 343.968 wires
- Large number of wires requires novel wiring procedure developed for MEG-II
- Mechanical assembly also separates gas containment/wire support functions leading to very low material in inner cylinder and end-plates
- Full sim in FCC framework and DCH model available in DD4hep



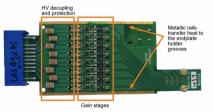


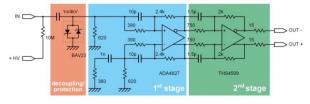




FE and DAQ electronics for a cluster counting drift chamber

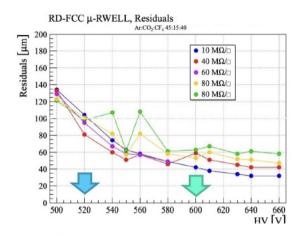
Gianluigi Chiarello INFN Lecce



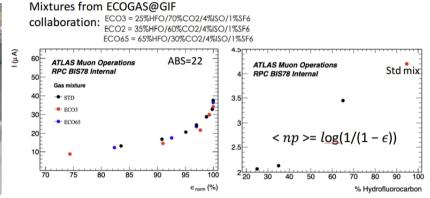


Muon chambers / MPRC TOF / Eco-friendly gas

- μ-RWELL: cheap, can sustain high rates => good choice for muon detectors of future collider detectors at large R (=>large area)
 - straight-forward for ee factories, requiring an R&D for the harsher conditions of SppC & FCC-hh
- Sealed MRPC was developed in THU (>7kHz/cm²)







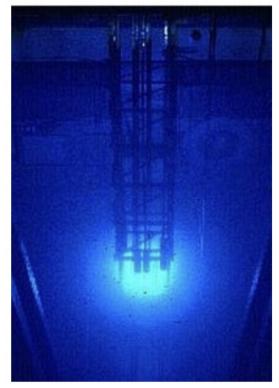
- RWELL detector was produced. Gain uniformity of ~ 14%@~5200 gain, and rate capability >100 kHz/cm2, are achieved.
- Search for Eco-friendly gases for gaseous detectors
- Long-term studies with HFO gas mixtures

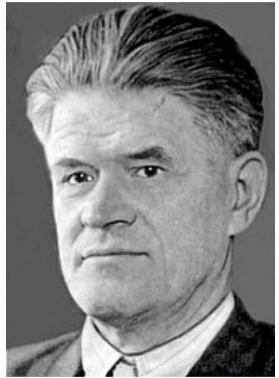
28/10/2022

Gas type GWP	
CO2 1	
HFC-134a 1430	
SF ₆ 23900	
HFO-1234ze 4	
He <1	
SF ₆ 23900 HFO-1234ze 4	



Pid & other technology

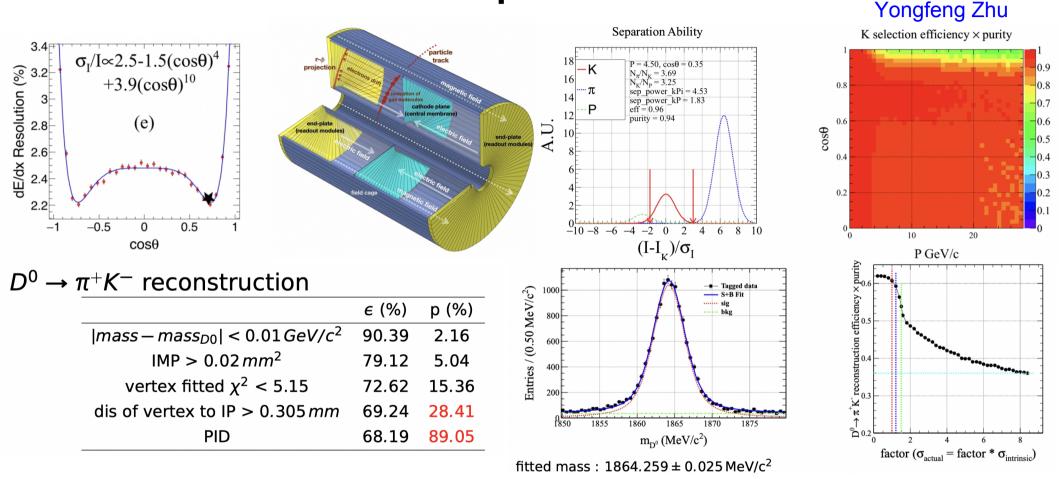




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Pid requirement

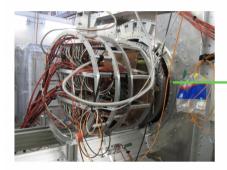


- Geant4: TPC @ baseline gives a resolution of 2.5% at MCTruth, together with 50 ps ToF, an overall eff/purity of 98%/97% is anticipated for Kaon@Z->qq, with significant dependence on polar angle.
- Physics object (D, Φ) reconstruction strongly suggest dE/dx resolution < 3%

TPC: Pad or Pixel

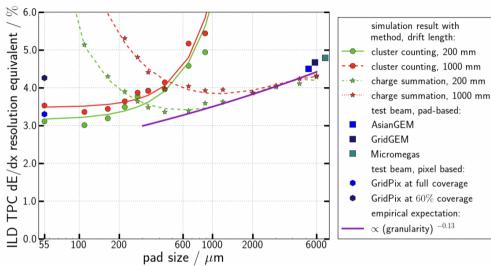


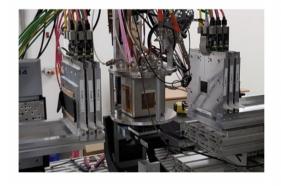
Ulrich Einhaus

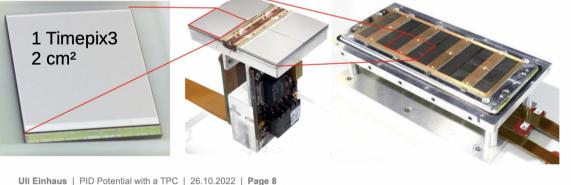


2 | Page 9



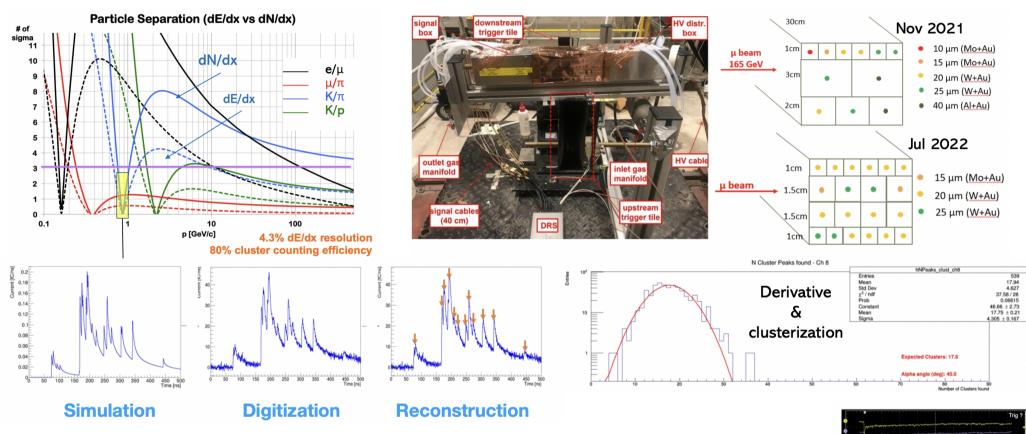






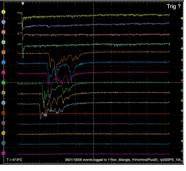
- TPX3
 TPX3
 TPX3
 TPX3
 Wire bonds
- 4.6 5%/3.3 3.6% dEdx resolution measured from TB, with Pad/Pixel readout
- Hopefully to be further improved with pad size optimization, noise control, etc

Drift Chamber: Cluster counting in time

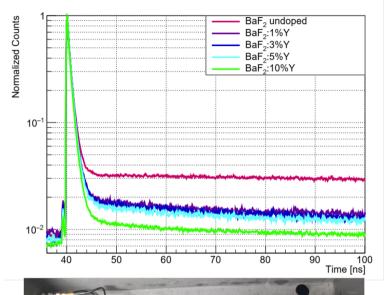


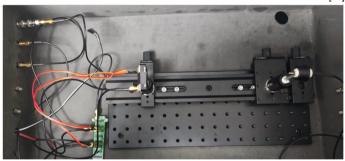
- Essential to have a high efficiency and accurate counting of Clusters
- Multiple peak finding algorithm are developed & tested
- Test beam result seems matched the expectation

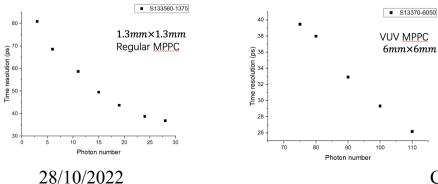
Brunella D'Anzi Federica Cuna, Yue Chang, Shuiting Xin

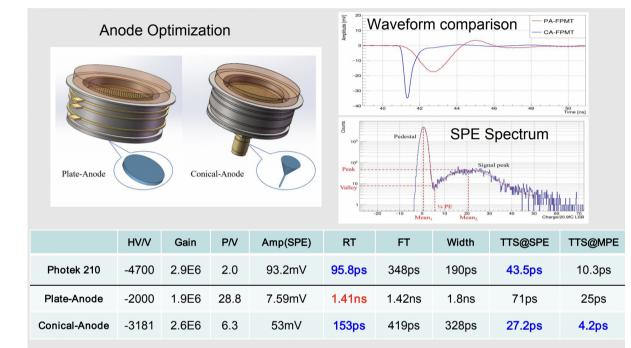


ToF with Xstal, etc

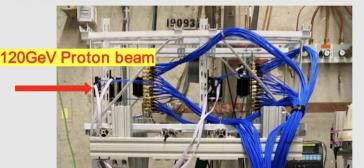








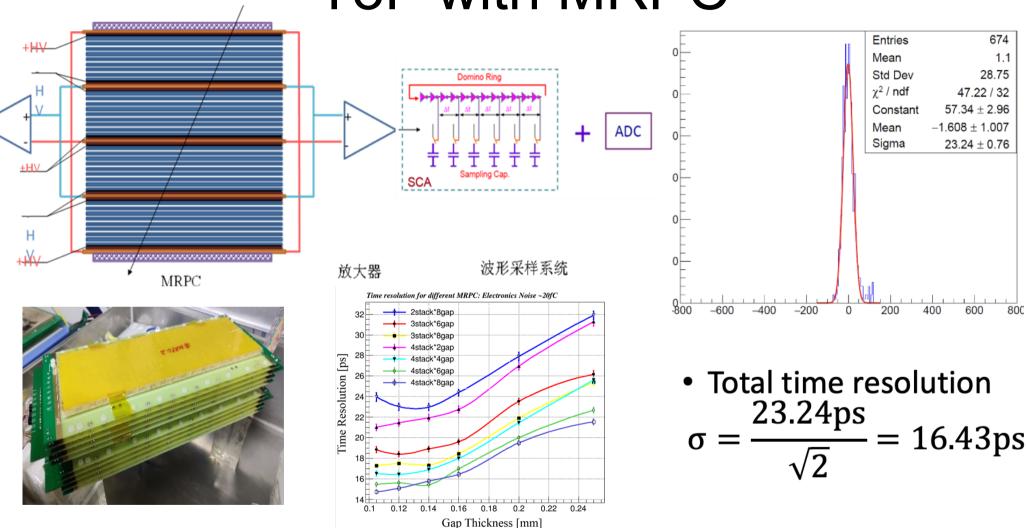
Ref: Lishuang MA et al., R & D of a novel single anode fast timing MCP-PMT, 2022, Pre-proof, NIMA.



- · Beam: 120GeV Proton
- Crystal: LYSO & BGO
- PMT: NNVT 8*8 FPMT
- DAQ: CAEN V1742~50ps



ToF with MRPC

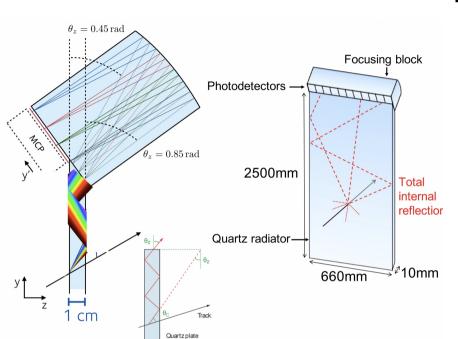


Technology used at STAR & CBM experiments (60 ps, o(100) m²)

Yi Wang

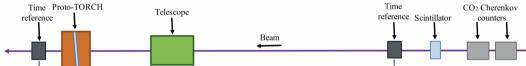
New tech: sealed MRPC, eco-friendly gas...

Torch

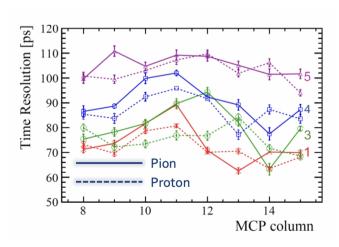


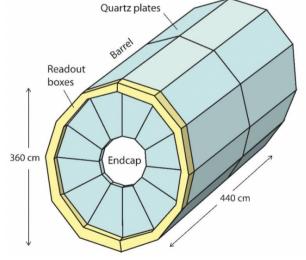
Maarten van Dijk





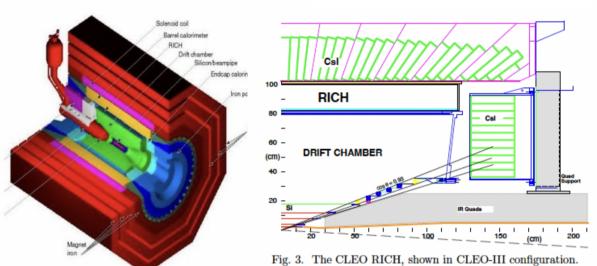
- ~70ps/photon reached for the LHCb upgrade
- Need ~ 25 ps/photon for ee Higgs factory
- Rely on better reco. Better electronics...





RICH @ CLEO

Marina Artuso





System Overview

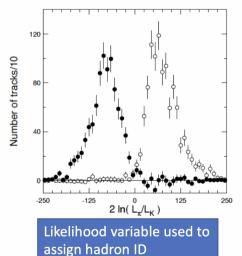
Outer ring of 30

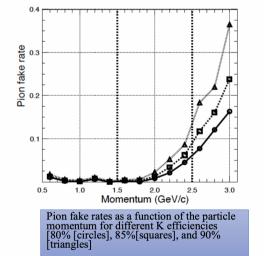
γ detectors

Inner ring of radiator tiles, 14

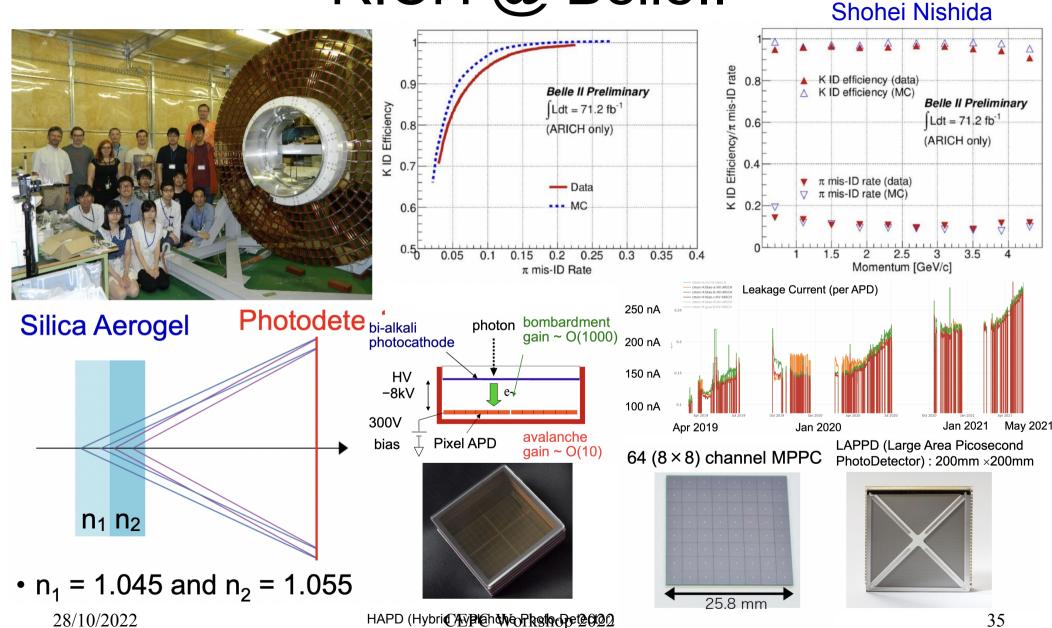
rows in length and 30 sectors in azimuth

N₂ + CH₄ TEA gas systems



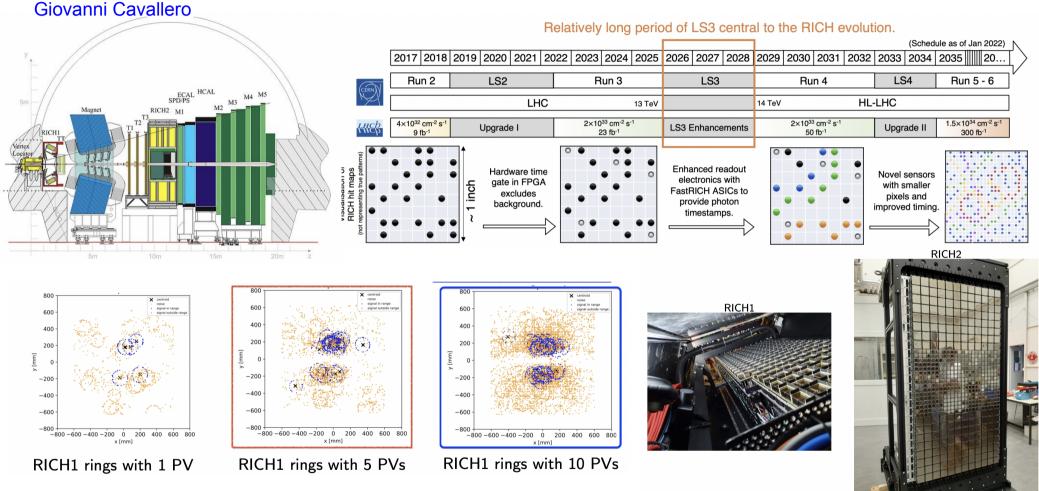


RICH @ Bellell





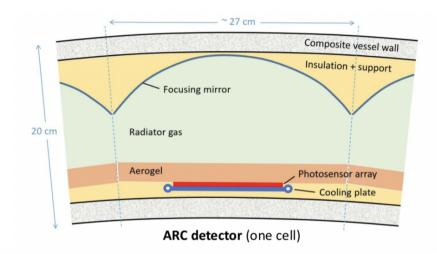
RICH @ LHCb



To address the challenges via fast electronics, high granularity & time measurement (LAPPD, MCP)...

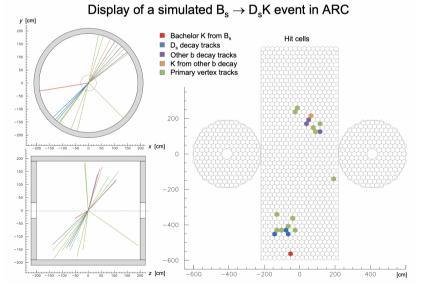


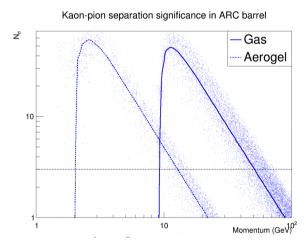
ARC (Array of RICH Cells)

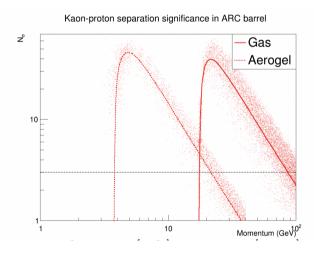




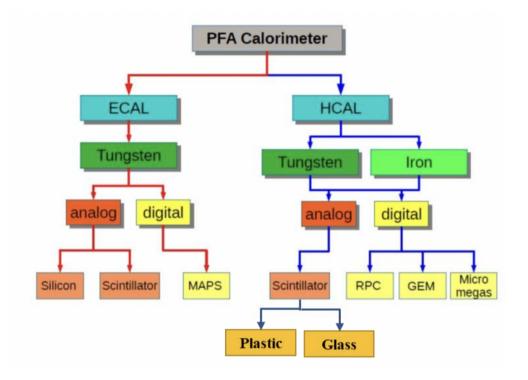
Martin Tat



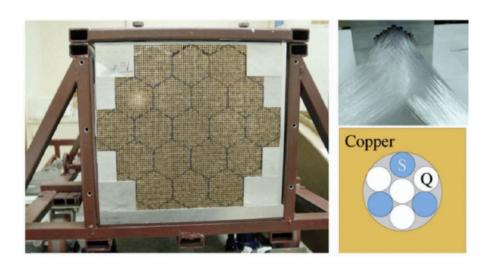




Lots to be explored(noise, PFA compatibility...) + promising performance up to 50 GeV!

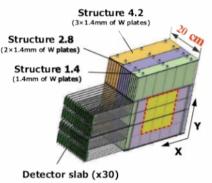


Calorimeter



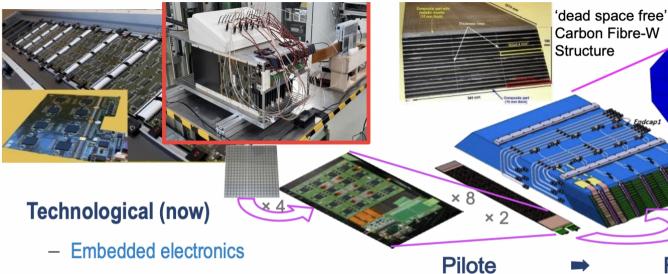
Si-W ECAL

Vincent Boudry

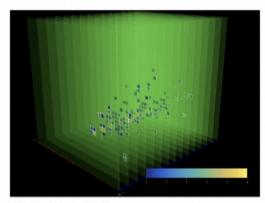


Physical (2005-11)





Electron



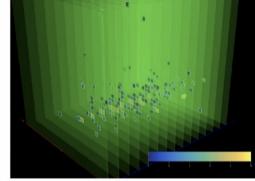


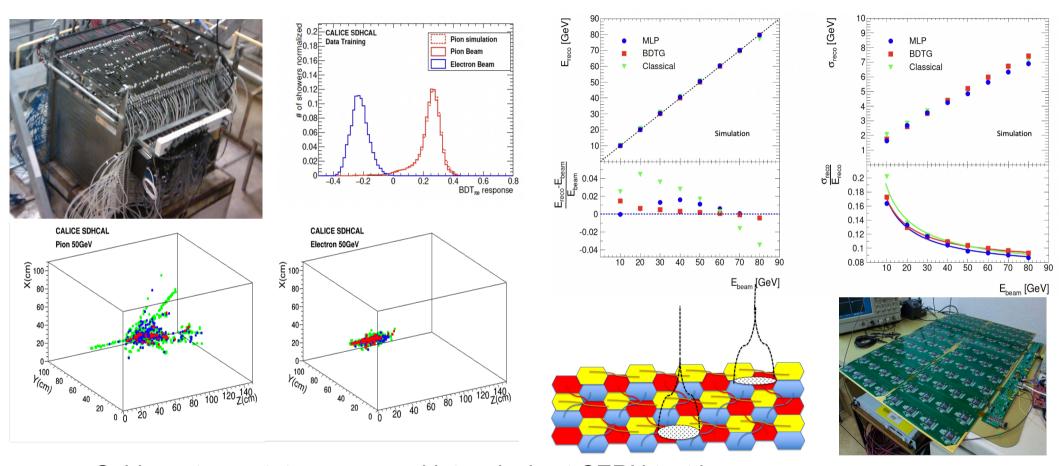
Fig. Simulation e- 10 GeV Fig. Reconstructed e- 10 GeV

 Intensive technology & optimization studies, and reconstruction algorithm, i.e., energy estimation, PFA (40+24)

Full Detector

SDHCAL

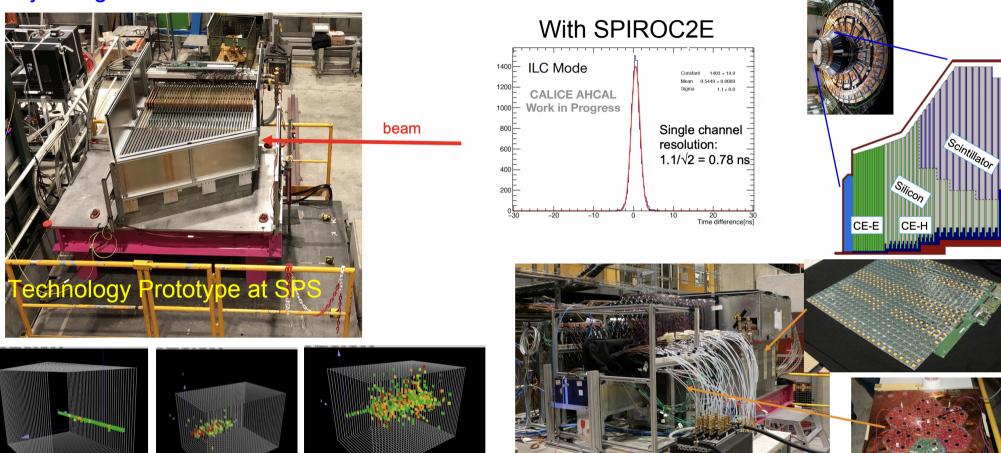
Imad Laktineh



- Cubic meter prototype exposed intensively at CERN test beam
- Excellent granularity, excellent particle identification + decent resolution
- Lots of R&D towards usage at linear & circular collider

AHCAL

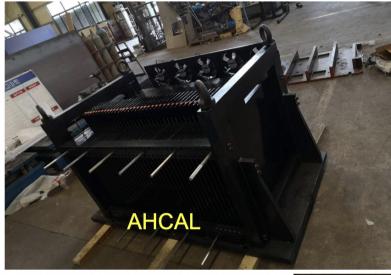
Katja Kruger



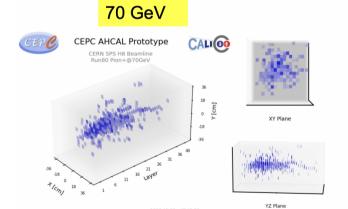
CMS HGCAL will be first detector scale application of this technology

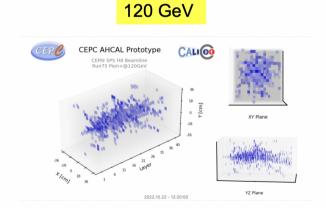
CEPC Calorimeter at SPS





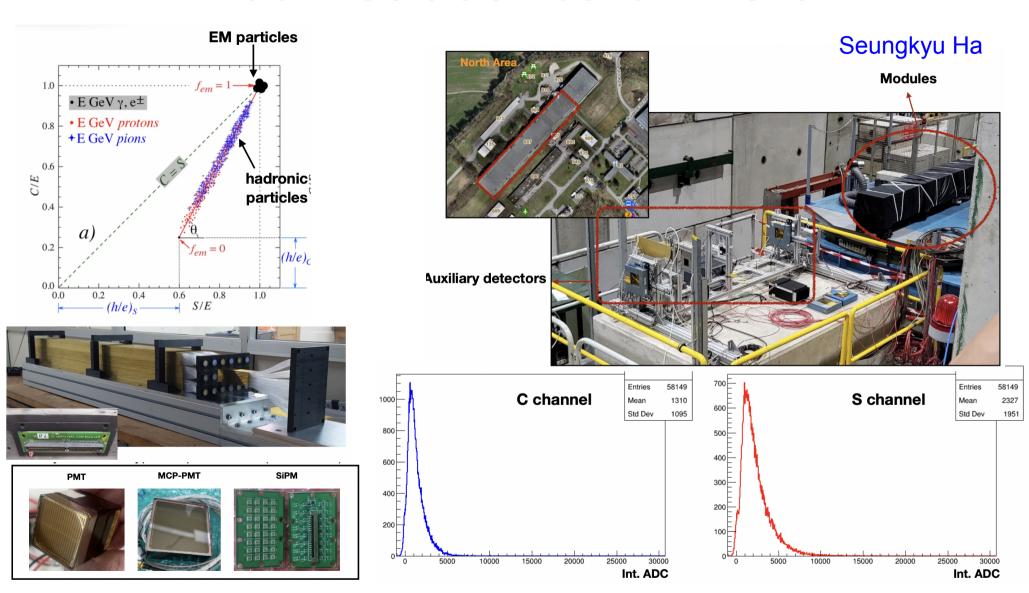




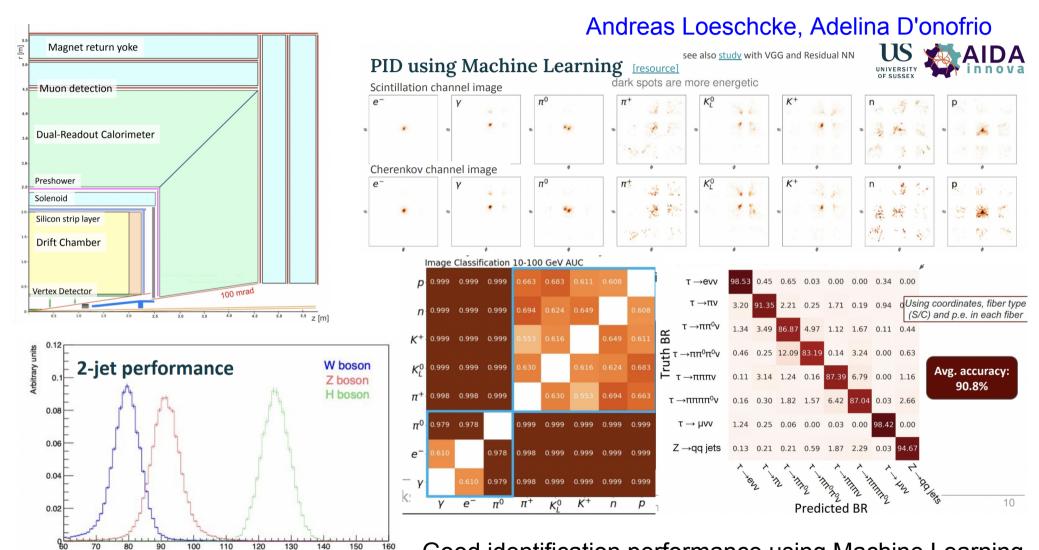




Dual readout calorimeter



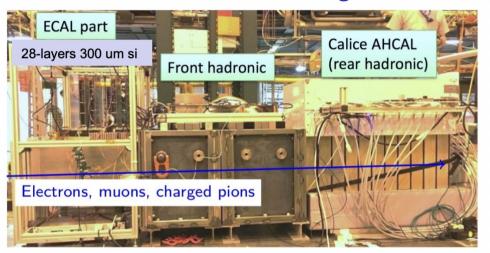
Dual readout calorimeter

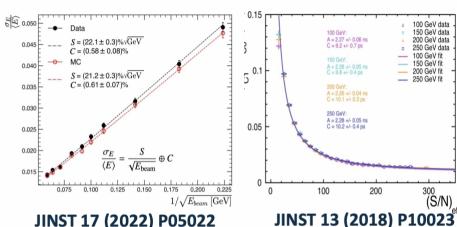


Good identification performance using Machine Learning... Particle Flow for Dual Readout is also being studied CEPC Workshop 2022

CMS HGC upgrade & IHEP

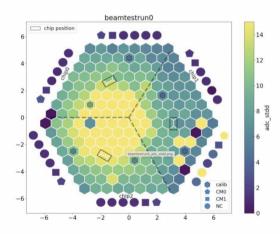
Beam tests in 2016-2018 using 6-inch silicon + SKIROC-cms modules and CALICE Sci. AHCAL





Switch to 8-inch silicon + HGCROC module at H2 beamline at CERN (SPS) Sept/Oct 2021





IHEP LD Module with HGCROCv2, 300mm silicon in September 21 beam test

Noise/MIP response in realistic environment in Si modules ROCv2 (Sep), ROCv3 (Oct), explored a range of working parameters with e-beams

Analysis on going

Huagiao Zhang

150 GeV data 200 GeV data

250 GeV data

100 GeV fit 150 GeV fit

200 GeV fit

300 (S/N)

Lots of synergies...

Calorimeter upgrade for ALICE, ATLAS and LHCb

Hua Pei

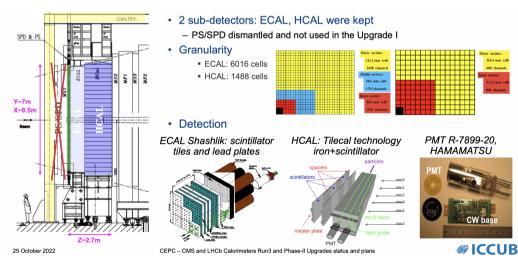




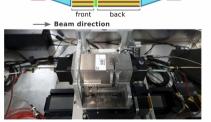
Summary

- Calorimeters at the ALICE and ATLAS experiments performed well throughout Run 1 and Run 2
 - Detailed operation and performance paper for Run 2 coming out
- Great physics output from all calorimeters: photon, hadron, charm/bottom, jet...
- Ready for Run 3: Many maintenance items taken care of over the long shutdown of last few years
- Exciting upgrades on the way: Run 3, Run 4, and beyond (2035-)

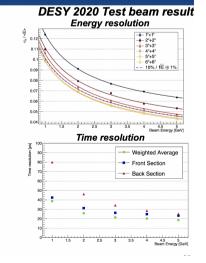
Eduardo Picatoste



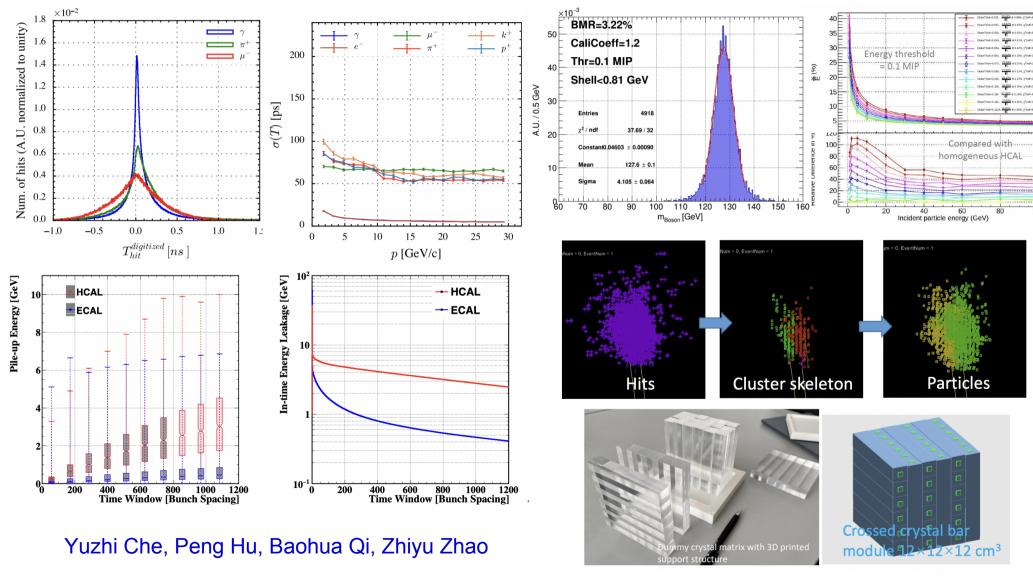
LHCb ECAL Upgrade II: SpaCal-W channel prototype



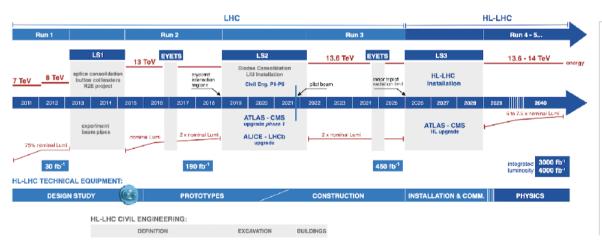
- SpaCal prototype module with W absorber and garnet crystal fibers:
 - Pure tungsten absorber with 19 g/cm³
 - 9 cells of 1.5x1.5 cm² (RM ≈ 1.45 cm)
 - -4+10 cm long (7+18 X_0)
 - Reflective mirror between sections



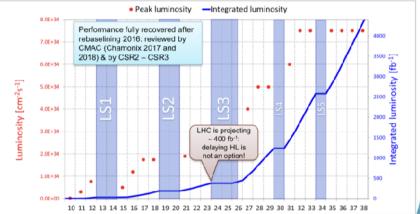
Performance



TDAQ & Software



ULTIMATE HL-LHC performace









The CMS Level-1 Muon Trigger focusing on the RPC

system

Ecs Asilar

Ready for Run 3

Phase-2 Upgrade Of Level-1 Trigger

Vladimir Rekovic nca Institute, University of Belgrade

Hardware demonstrators



Conclusion

As a result of successful performance at CERN 904 Lab, *GIF++ and at the CMS cavern, currently, demonstrator* iRPCs are getting ready for taking data during Run3 to further validate the performance for Phase II operations.

ATLAS Data Acquisition Phase 2 Outlook

ATCA boards hosting powerful Xilinx Ultrascale+ FPGAs with high I/O are designed

BMTI 1

- Prototypes vailable in different flavors for Phase-2 L1-Trigger (optics Firefly or QSFP)
 - "X20" for OMTF, EMTF, GMT (moving from Ocean in TDR)
- - 'Serenity" for GCT, Correlator, GT
- "APx" (GCT)

Serenity

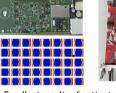


Ongoing Slice Test of FW with hardware connecting multiple boards of different flavors.



Progressing well towards electronics readiness review in O1/2 2023.

X20



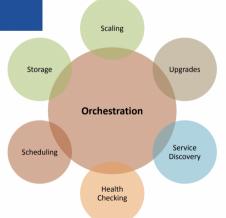


Preparing for phase Sylvain Chapeland nissioning

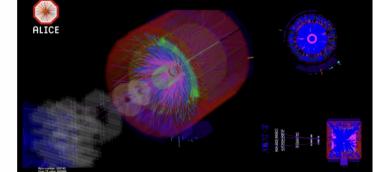
Matías Bonaventura, CERN On behalf of ATLAS TDAQ Collaboration

Conclusions

- HL-LHC upgrade requires a major upgrade of all components of the ATLAS TDAQ
- Impact of technology evolution
 - Full event building thanks to network improvements
 - Persistent storage design on hold due to increased storage cost and endurance u
 - RDMA-based readout network
 - Management of processing farm with Kubernetes orchestration
- Upcoming challenges
 - Close interaction with industry to track technology updates
 - Incorporate experience from run 3 operations



CEPC Workshop 2022



5 July 2022: ALICE first 13.6 TeV collisions of LHC Run 3.

- ALICE started Run 3 with success
 - Actively taking p-p physics data
 - Exercising data flow and processing with p-p at high rates
 - Waiting for HI collisions

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See also talk of M. Boulais

28/10/2022









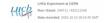
ALICE Trigger System Run3

R. Lietava for the ALICE Collaboration

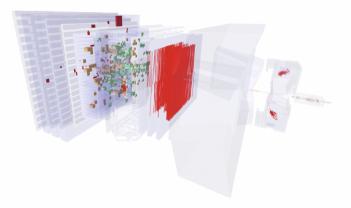
The University of Birmingham



LHCb HLT1 Tracking and vertexing a 30 MHz with GPUs



Marianna Fontana



Conclusion

- LHCb is currently undergoing its first major upgrade in order to increase its instantaneous luminosity by x5
- Major changes in the trigger strategy:
 - Remove L0 hardware trigger, read-out full detector at 30 MHz
 - New first level trigger run on GPUs
- Partial event reconstruction and trigger selection lines implemented with excellent physics performance expected
- The system can be realised with ~200 GPUs (throughput ~170 kHz)
- · GPUs are installed in the EB server and the commissioning is ongoing
- LHCb is almost ready to start collecting physics data with the brand new detector

Summary

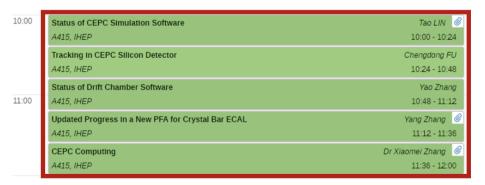
- Most of the detectors take data in triggerless mode: read out data of all interactions (50kHz Pb-Pb and > 500kHz pp)
 - Compress these data by online reconstruction
 - One common online-offline system
- Central trigger system:
 - Distributes clock and HB frame delimiter
 - Provides Minimum Bias trigger when needed
 - Provides Continuous/Triggered Mode as required
- Operation
 - Trigger system providing clock, HB and triggers since October 2021

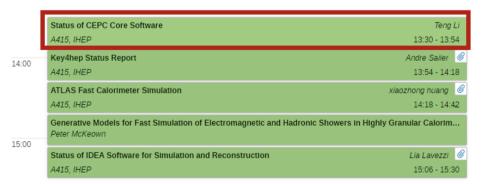
Highly relevant, & encouraging experience for CEPC, etc.

We need to better understand the requirements stemmed from sys. control

Offline & Computing (1)

- Recent development of CEPCSW focus on the core software, simulation and reconstruction to support the 4th concept detector design.
- Highlights
 - R&D on advanced computing technologies in framework: heterogeneous computing with TRACCC from ACTS, integration of ML using ONNX, RDataFrame based analysis toolkit, Gaussino based simulation framework.
 - Extension of EDM4hep for dN/dx and completed chain of dN/dx study.
 - Support multi-track fitting with silicon detector and drift chamber.
 - New reconstruction algorithms for long crystal bar ECAL: clustering, shower recognition, energy splitting and energy/time matching.
 - Sharing computing resources between CEPC and ILC: adding 640 CPU cores in 2022



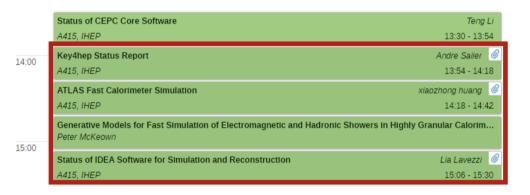


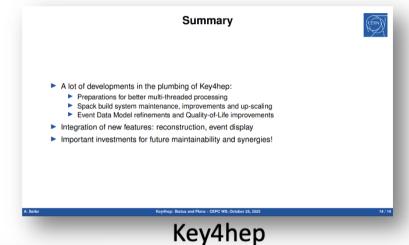
Talks could be found in https://indico.ihep.ac.cn/event/17020/sessions/10728/#20221028

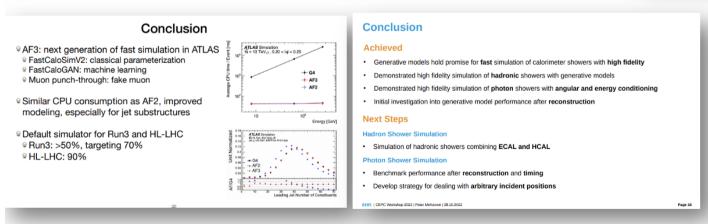
Offline & Computing (2)

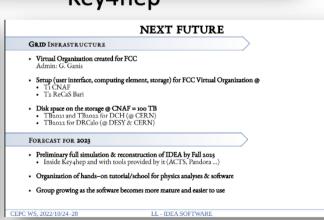
Four invitation talks on Key4hep, ATLAS fast simulation, ILD ECAL/HCAL

fast simulation, IDEA software









Fast simulation based on generative models

IDEA software

Summary

- Lots of excellent talks/reviews
- Significant progress, with indispensable international collaboration
 - Delivered prototypes + promising results
 - New ideas + advanced technologies
- CEPC poses stringent requirement, has strong synergies with other projects
 - Successful operation & detector upgrade at LHC, SuperKEKb, etc.
 - Common R&D for other Higgs factories & beyond
- Multiple IPs: multiple detector with optimized design & different technologies
- To pursuing new ideas, better performance, & new technologies via significant R&D with in-depth international collaboration - to benefit not only CEPC/HEP research, but also other disciplines & on society

Thank you

to speaks, conveners, and enthusiastic participants

to my colleagues helped prepare the slides: Yiming Li, Tao Lin, Huirong Qi, Yaquan Fang, Zhijun Liang, Haoyu Shi, etc

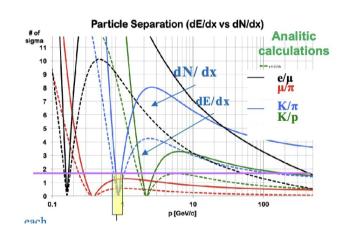
Hope to see you in person, and work together soon!

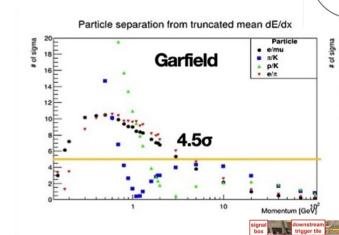
Backup

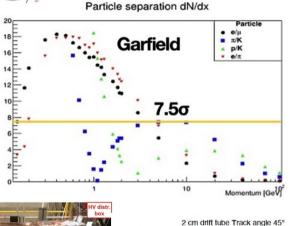
IDEA drift chamber: improved PID w/ cluster counting

Gianluigi Chiarello

• Particle identification with ionisation loss measurement: significant improvement expected in resolution and K/π separation from cluster counting rather than dE/dx







drift tube

 Beam test at CERN in 2021 with 165 GeV muon beam to tune algorithms for cluster identification and counting

- Beam test at CERN in 2022 with muons of 40, 80 and 180 GeV, analysis in progress
- Next: beam tests foreseen at PSI and Fermilab to cover wide range of βγ

